

WST2026

N-Channel MOSFET

General Description

The WST2026 is the highest performance trench N-ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the small power switching and load switch applications.

The WST2026 meet the RoHS and Green Product requirement with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

Product Summery

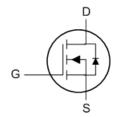
BVDSS	RDSON	ID
20V	65mΩ	2.0A

Applications

- High Frequency Point-of-Load Synchronous Small power switching for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

SOT-323 Pin Configuration





Absolute Maximum Ratings

Symbol	Parameter	Rating	Units	
V _{DS}	Drain-Source Voltage	20	V	
V _{GS}	Gate-Source Voltage	±12	V	
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 4.5V ¹	2.0	A	
I _D @T _C =70℃	Continuous Drain Current, V _{GS} @ 4.5V ¹	1.0	А	
I _{DM}	Pulsed Drain Current ²	16	А	
P _D @T _A =25℃	Total Power Dissipation ³	0.4	W	
T _{STG}	Storage Temperature Range -55 to 150		°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{eja}	Thermal Resistance Junction-ambient ¹		125	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹		85	°C/W



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Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	20			V
∆BV _{DSS} /∆T _J	BVDSS Temperature Coefficient	Reference to 25 $^\circ\!\mathrm{C}$, I_D=1mA		0.022		V/℃
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =2A		65	85	mΩ
		V _{GS} =4.5V , I _D =1A		80	100	
V _{GS(th)}	Gate Threshold Voltage		0.5	0.8	1.5	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$-V_{GS}=V_{DS}$, $I_D=250$ uA		-2.33		mV/℃
	Drain-Source Leakage Current	V_{DS} =16V , V_{GS} =0V , T _J =25 $^{\circ}$ C			1	uA
I _{DSS}		V_{DS} =16V , V_{GS} =0V , T _J =55 $^\circ$ C			5	uA
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm12V$, $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =2A		15		S
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.5	3	Ω
Qg	Total Gate Charge (4.5V)			7.6	10	
Q _{gs}	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V , I _D =2A		1.3	2.0	nC
Q _{gd}	Gate-Drain Charge			1.7	3.8	
T _{d(on)}	Turn-On Delay Time	V_{DD} =10V , V _{GS} =4.5V , R _G =6.0Ω I _D =2A		11	22	
Tr	Rise Time			3.2	6.5	- ns
T _{d(off)}	Turn-Off Delay Time			22	45	
T _f	Fall Time			3.0	6.0	
C _{iss}	Input Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		391		
C _{oss}	Output Capacitance			87		pF
Crss	Reverse Transfer Capacitance			60]

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,4}				2.0	А
I _{SM}	Pulsed Source Current ^{2,4}	$V_G = V_D = 0V$, Force Current			15	А
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25℃			1.0	V
trr	Reverse Recovery Time			11	25	nS
Q _{rr}	Reverse Recovery Charge	l ⊧=2A , dl/dt=100A/µs , T _J =25℃		6.8	14	nC

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.

2.The data tested by pulsed , pulse width $\,\leq\,$ 300us , duty cycle $\,\leq\,$ 2%

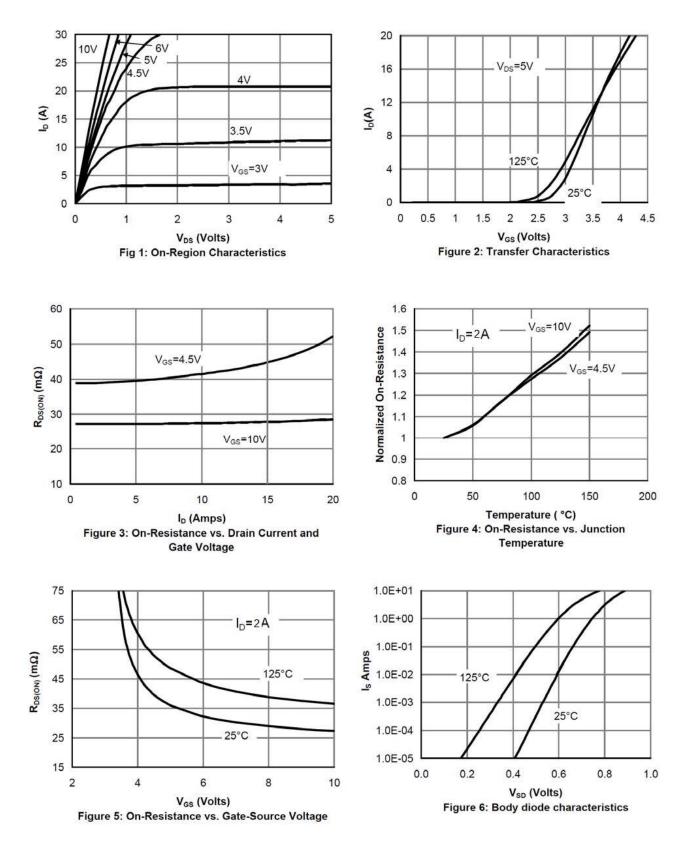
3.The power dissipation is limited by 150 $^\circ C$ junction temperature

4. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



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Typical Characteristics





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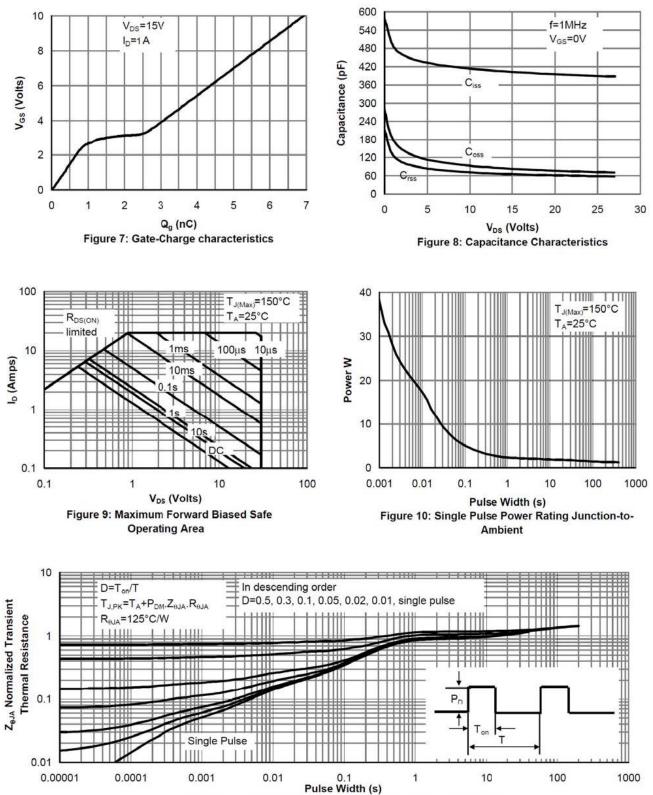


Figure 11: Normalized Maximum Transient Thermal Impedance



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